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APPLICATION FOR LETTERS PATENT

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A BATTERY POWERABLE APPARATUS, RADIO FREQUENCY COMMUNICATION DEVICE, AND ELECTRIC CIRCUIT

~~Thin Profile Battery Bonding Method, Method Of
Conductively Interconnecting Electronic Components,
Battery Powerable Apparatus, Radio Frequency
Communication Device, And Electric Circuit~~

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1 ~~Thin Profile Battery Bonding Method, Method Of Conductively~~
2 ~~Interconnecting Electronic Components, Battery Powerable Apparatus,~~
3 Radio Frequency Communication Device, And Electric Circuit

3 b
4 Ins. A

5 TECHNICAL FIELD

6 This invention relates to thin profile battery bonding methods, to
7 methods of conductively interconnecting electronic components, to battery
8 powerable apparatus, to radio frequency communication devices, and to
9 electric circuits.

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11 BACKGROUND OF THE INVENTION

12 Thin profile batteries comprise batteries that have thickness
13 dimensions which are less than a maximum linear dimension of its
14 anode or cathode. One type of thin profile battery is a button type
15 battery. Such batteries, because of their compact size, permit electronic
16 devices to be built which are very small or compact.

17 One mechanism by which thin profile batteries are electrically
18 connected with other circuits or components is with electrically
19 conductive adhesive, such as epoxy. Yet in some applications, a suitably
20 conductive bond or interconnection is not created in spite of the highly
21 conductive nature of the conductive epoxy, the outer battery surface,
22 and the substrate surface to which the battery is being connected. This
23 invention arose out of concerns associated with providing improved
24 conductive adhesive interconnections between thin profile batteries and

1 components to be electrically interconnected. At least one of the
2 components comprises a metal surface with which the curable epoxy is
3 to electrically connect. The epoxy is cured into an electrically
4 conductive bond electrically interconnecting the first and second
5 components. The epoxy has an effective metal surface wetting
6 concentration of silane to form a cured electrical interconnection having
7 a contact resistance through said metal surface of less than or equal to
8 about 0.3 ohm-cm².

9 The invention in a further aspect includes a battery powerable
10 apparatus. In one implementation, such includes a substrate having a
11 surface comprising at least one node location. A thin profile battery
12 is mounted over the substrate and node location. A conductive
13 adhesive mass electrically interconnects the thin profile battery with the
14 node location, with the conductive adhesive mass comprising an epoxy
15 terminated silane.

16 The invention in still a further aspect includes a radio frequency
17 communication device. In one implementation, such includes a substrate
18 having conductive paths including an antenna. At least one integrated
19 circuit chip is mounted to the substrate and in electrical connection with
20 a first portion of the substrate conductive paths. A thin profile battery
21 is conductively bonded with a second portion of the substrate conductive
22 paths by a conductive adhesive mass, with the conductive adhesive mass
23 comprising an epoxy terminated silane.
24

1 The invention in still another aspect includes an electric circuit
2 comprising first and second electric components electrically connected
3 with one another through a conductive adhesive mass comprising an
4 epoxy terminated silane.

5 6 BRIEF DESCRIPTION OF THE DRAWINGS

7 Preferred embodiments of the invention are described below with
8 reference to the following accompanying drawings.

9 Fig. 1 is a side elevational, partial cross sectional, view of a thin
10 profile battery.

11 Fig. 2 is a side elevational view of a substrate.

12 Fig. 3 is a side elevational view of a battery powerable apparatus.

13 Fig. 4 is a diagrammatic plan view of a radio frequency
14 communication device.

15 16 DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

17 This disclosure of the invention is submitted in furtherance of the
18 constitutional purposes of the U.S. Patent Laws "to promote the
19 progress of science and useful arts" (Article 1, Section 8).

20 Referring to Fig. 1, a single thin-profile battery is indicated
21 generally with reference numeral 10. In the context of this document,
22 "thin-profile battery" is intended to define any battery having a thickness
23 dimension which is less than a maximum linear dimension of its anode
24 or cathode. The preferred and illustrated battery 10 comprises a

1 circular button-type battery. Such comprises a lid terminal housing
2 member 14 and a can terminal housing member 12. Can 12 is crimped
3 about lid 14, having an insulative sealing gasket 16 interposed
4 therebetween. In the illustrated example, gasket 16 projects outwardly
5 slightly relative to the crimp as shown.

6 Fig. 2 illustrates a substrate 22 to which thin-profile battery 10
7 is to be conductively connected. Substrate 22 includes an outer
8 surface 23 having one node location 24 and another node location 25
9 to which battery electrical connection is desired. Substrate 22, for
10 example, can comprise a flexible circuit substrate, wherein nodes 24
11 and 25 comprise printed thick film ink formed on surface 23.

12 Referring to Fig. 3, a curable adhesive composition or mass 26
13 comprising an epoxy-terminated silane is interposed between lid 14 of
14 thin profile battery 10 and substrate 22 over node location 25. Further,
15 a curable adhesive composition or mass 32 comprising an
16 epoxy-terminated silane is interposed between can 12 of thin-profile
17 battery 10 and node location 24 on substrate 22. The preferred
18 curable adhesive composition comprises a two-part epoxy resin and
19 hardener system, wherein the preferred epoxy-terminated silane comprises
20 a glycidoxy methoxy silane, such as a glycidoxypropyltrimethoxysilane,
21 with 3-glycidoxypropyltrimethoxysilane being a specific example. The
22 epoxy-terminated silane is preferably present in the curable adhesive
23 composition at less than or equal to about 2% by weight, with less
24 than or equal to about 1% by weight being even more preferred.

when ignoring the volume resistances of the epoxy mass and substrate. At the time of preparation of this document, 10 ohms (and its associated calculated contact resistance of 0.32 ohm-cm^2) is considered high and unacceptable for purposes and applications of the assignee, such as will be described with reference to Fig. 4. Yet where the epoxy-terminated silane was added, for example at a weight percent of 2% or less, the typical resistance value and range dropped significantly to 0.1 ohm to 1.0 ohm, with 0.2 ohm being typical. These correspond to respective contact resistances of about 0.0032 ohm-cm^2 , 0.032 ohm-cm^2 , and 0.0064 ohm-cm^2 .

It is perceived that the prior art conductive bonding without the epoxy-terminated silane results from poor wetting characteristics of the conductive epoxy with the metal outer surface of the button-type battery, which typically comprises a nickel-clad stainless steel. The epoxy-terminated silane significantly improves the wetting characteristics relative to the metal surfaces, such as nickel-clad stainless steel, in a conductive epoxy system in a manner which is not understood to have been reported or known in the prior art. Accordingly in accordance with another aspect of the invention, a thin-profile battery bonding method interposes epoxy between a battery and substrate with at least one of such having a metal surface to which the curable epoxy is to electrically connect. The epoxy has an effective metal surface wetting concentration of silane to form a cured electrical interconnection having a contact resistance through said metal surface of less than or equal to

